

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Dan McDermott	08/24/2011
Richard L. Johnson, Jr.	08/25/2011
RECEIVING PARTY DATA	
Name:	Emcore Corporation
Street Address:	10420 Research Road SE
City:	Albuquerque
State/Country:	NEW MEXICO
Postal Code:	87123
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13217812
CORRESPONDENCE DATA	
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
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Email:	nliberko@kaganbinder.com
Correspondent Name:	Kagan Binder, PLLC
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Address Line 2:	Suite 200
Address Line 4:	Stillwater, MINNESOTA 55082
ATTORNEY DOCKET NUMBER:	B451 (EMC0059/US)
NAME OF SUBMITTER:	Paul J. Parins
Total Attachments: 4 source=EMC0059US_B451_Signed_Assignment_08_25_11#page1.tif source=EMC0059US_B451_Signed_Assignment_08_25_11#page2.tif source=EMC0059US_B451_Signed_Assignment_08_25_11#page3.tif source=EMC0059US_B451_Signed_Assignment_08_25_11#page4.tif	

CH \$40.00 13217812

ASSIGNMENT

WHEREAS, Dan McDermott, residing in 15465 Ramona Ave., Fontana, CA 92336 USA, citizen of the United States, and Richard L. Johnson, Jr., residing in 6106 Walkers Ferry Lane, Suffolk, VA 23435 USA, citizen of the United States, (hereinafter "ASSIGNOR") is/are the inventor(s) of the invention entitled CONCENTRATING PHOTOVOLTAIC SYSTEM MODULE WITH ACTUATOR CONTROL for which I/we have executed an application for a Patent of the United States on the even date herewith,

And WHEREAS, Emcore Corporation (hereinafter "ASSIGNEE"), a New Jersey Corporation having a business address at 10420 Research Road SE, Albuquerque, New Mexico 87123, is desirous of obtaining our entire right, title and interest in, to and under the said invention and the said application, in all countries outside of the Peoples Republic of China;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to me in the hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, I/WE, the said ASSIGNOR(s), have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, except for Peoples Republic of China, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States, except for Peoples Republic of China, and all extensions, renewals and reissues thereof;

AND I/WE HEREBY authorize and request the Commissioner of Patents and Trademarks of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I/WE HEREBY covenant and agree that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I/WE HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries

IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year opposite my signature.

8/24/11
(Date)


Dan McDermott (Signature)

(Date)

Richard L. Johnson, Jr. (Signature)

#68629

ASSIGNMENT

WHEREAS, Dan McDermott, residing in 15465 Ramona Ave., Fontana, CA 92336 USA, citizen of the United States, and Richard L. Johnson, Jr., residing in 6106 Walkers Ferry Lane, Suffolk, VA 23435 USA, citizen of the United States, (hereinafter "ASSIGNOR") is/are the inventor(s) of the invention entitled CONCENTRATING PHOTOVOLTAIC SYSTEM MODULE WITH ACTUATOR CONTROL for which I/we have executed an application for a Patent of the United States on the even date herewith,

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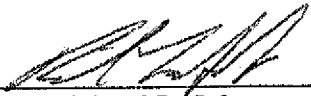
AND I/WE HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries

IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year opposite my signature.

(Date)

Dan McDermott (Signature)

8/25/2011
(Date)



Richard L. Johnson, Jr. (Signature)

#68629